HEF4520B

Dual binary counter Rev. 6 — 18 November 2011

Product data sheet

1. **General description**

The HEF4520B is a dual 4-bit internally synchronous binary counter. The counter has an active HIGH clock input (nCP0) and an active LOW clock input (nCP1), buffered outputs from all four bit positions (nQ0 to nQ3) and an active HIGH overriding asynchronous master reset input (nMR).

The counter advances on either the LOW-to-HIGH transition of the nCP0 input if nCP1 is HIGH or the HIGH-to-LOW transition of the nCP1 input if nCP0 is LOW. Either nCP0 or nCP1 may be used as the clock input to the counter while the other clock input may be used as a clock enable input. Schmitt trigger action makes the clock input highly tolerant of slower clock rise and fall times. A HIGH on nMR resets the counter (nQ0 to nQ3 = LOW) independent of nCP0 and $n\overline{CP1}$.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

Ordering information 3.

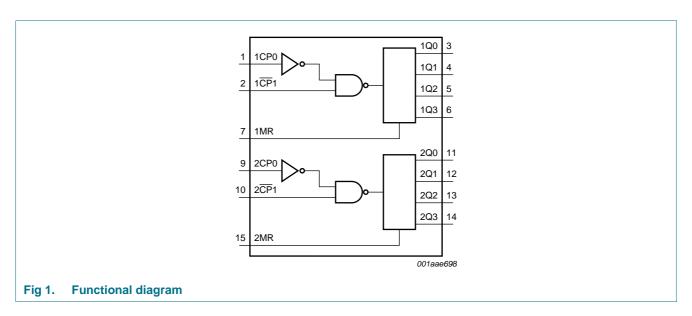
Ordering information Table 1.

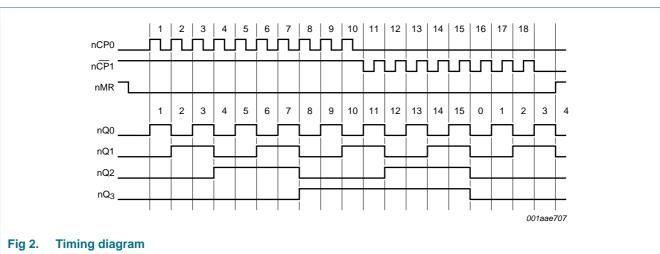
All types operate from -40 °C to +85 °C.

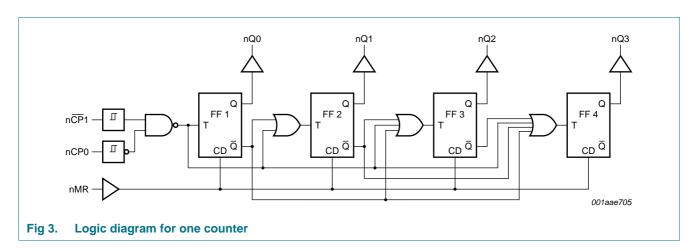
Type number	Package									
	Name	Description	Version							
HEF4520BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4							
HEF4520BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1							



4. Functional diagram

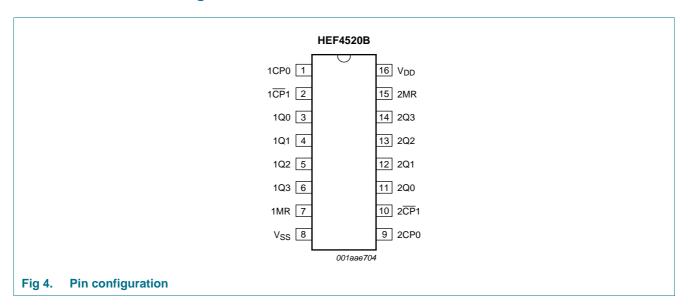






5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP0, 2CP0	1, 9	clock input (LOW-to-HIGH triggered)
1CP1, 2CP1	2, 10	clock input (HIGH-to-LOW triggered)
1Q0 to 1Q3	3, 4, 5, 6	output
1MR, 2MR	7, 15	master reset input
V _{SS}	8	ground supply voltage
2Q0 to 2Q3	11, 12, 13, 14	output
V_{DD}	16	supply voltage

6. Functional description

Table 3. Function table[1]

nCP0	nCP1	nMR	Mode
\uparrow	Н	L	counter advances
L	\	L	counter advances
\	X	L	no change
X	↑	L	no change
\uparrow	L	L	no change
Н	\	L	no change
X	X	Н	nQ0 to nQ3 = LOW

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; $\uparrow = positive-going transition$; $\downarrow = negative-going transition$.

HEF4520E

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	supply voltage		-0.5	+18	V
I _{IK}	input clamping current	$V_I < -0.5 \text{ V or } V_I > V_{DD} + 0.5 \text{ V}$	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
lok	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{DD} + 0.5 \text{ V}$	-	±10	mA
$I_{I/O}$	input/output current		-	±10	mA
I_{DD}	supply current		-	50	mA
T _{stg}	storage temperature	per output	- 65	+150	°C
T _{amb}	ambient temperature		-40	+85	°C
P _{tot}	total power dissipation	DIP16 package	<u>[1]</u> -	750	mW
		SO16 package	[2] _	500	mW
Р	power dissipation		-	100	mW

^[1] For DIP16 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
Δt/ΔV input transition rise and fall r		$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

^[2] For SO16 package: Ptot derates linearly with 8 mW/K above 70 °C.

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0 \ V$; $V_I = V_{SS}$ or V_{DD} unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	–40 °C	T _{amb} =	: 25 °C	T _{amb} =	85 °C	Unit
				Min	Max	Min	Max	Min	Max	
V_{IH}	HIGH-level input voltage	$ I_{O} < 1 \mu A$	5 V	3.5	-	3.5	-	3.5	-	V
			10 V	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	V
V_{IL}	LOW-level input voltage	$ I_{O} < 1 \mu A$	5 V	-	1.5	-	1.5	-	1.5	V
			10 V	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage		5 V	4.95	-	4.95	-	4.95	-	V
		$V_I = V_{SS}$ or V_{DD}	10 V	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	V
V_{OL}	LOW-level output voltage	$ I_O < 1 \mu A;$	5 V	-	0.05	-	0.05	-	0.05	V
		$V_I = V_{SS}$ or V_{DD}	10 V	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	V
I _{OH}	HIGH-level output current	$V_0 = 2.5 \text{ V}$	5 V	-	-1.7	-	-1.4	-	-1.1	mA
		$V_0 = 4.6 \text{ V}$	5 V	-	-0.52	-	-0.44	-	-0.36	mA
		$V_0 = 9.5 \text{ V}$	10 V	-	-1.3	-	-1.1	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-3.6	-	-3.0	-	-2.4	mΑ
I _{OL}	LOW-level output current	$V_0 = 0.4 \ V$	5 V	0.52	-	0.44	-	0.36	-	mΑ
		$V_0 = 0.5 \ V$	10 V	1.3	-	1.1	-	0.9	-	mA
		V _O = 1.5 V	15 V	3.6	-	3.0	-	2.4	-	mA
I _I	input leakage current	$V_{DD} = 15 \text{ V}$	15 V	-	±0.3	-	±0.3	-	±1.0	μΑ
I _{DD}	supply current	$I_{O} = 0 A;$	5 V	-	20	-	20	-	150	μΑ
		$V_I = V_{SS}$ or V_{DD}	10 V	-	40	-	40	-	300	μΑ
			15 V	-	80	-	80	-	600	μΑ
Cı	input capacitance		-	-	-	-	7.5	-	-	pF
	• •									

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $V_{SS} = 0 \text{ V}$; $T_{amb} = 25 \text{ °C}$; for test circuit see Figure 6; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PHL} HIGH to LOW propagation del		nCP0, n $\overline{CP1} \rightarrow nQn$;	5 V	[1] 83 ns + (0.55 ns/pF)C _L	-	110	220	ns
	propagation delay	see Figure 5	10 V	39 ns + $(0.23 \text{ ns/pF})C_L$	-	50	100	ns
			15 V	32 ns + $(0.16 \text{ ns/pF})C_L$	-	40	80	ns
		$nMR \rightarrow nQn;$	5 V	48 ns + $(0.55 \text{ ns/pF})C_L$	-	75	150	ns
		see Figure 5	10 V	24 ns + (0.23 ns/pF)C _L	-	35	70	ns
			15 V	17 ns + $(0.16 \text{ ns/pF})C_L$	-	25	50	ns

 Table 7.
 Dynamic characteristics ...continued

 $V_{SS} = 0 \text{ V}$; $T_{amb} = 25 \,^{\circ}\text{C}$; for test circuit see <u>Figure 6</u>; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	Extrapolation formula	Min	Тур	Max	Unit
t _{PLH}	LOW to HIGH	nCP0, $n\overline{CP}1 \rightarrow nQn$;	5 V	11 83 ns + (0.55 ns/pF)C _L	-	110	220	ns
	propagation delay	see Figure 5	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
t _t	transition time	nQn; see Figure 5	5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _W	pulse width	nCP0 input LOW; minimum width; see Figure 5	5 V		60	30	-	ns
			10 V		30	15	-	ns
		see <u>Figure 5</u>	15 V		20	10	-	ns
		nCP1 input HIGH; minimum width;	5 V		60	30	-	ns
			10 V		30	15	-	ns
		see Figure 5	15 V		20	10	-	ns
		nMR input HIGH; minimum width; see <u>Figure 5</u>	5 V		30	15	-	ns
			10 V		20	10	-	ns
			15 V		16	8	-	ns
t _{su}	set-up time	$nCP0 \rightarrow n\overline{CP1}$;	5 V		50	25	-	ns
		see Figure 5	10 V		30	15	-	ns
			15 V		20	10	-	ns
		$n\overline{CP}1 \rightarrow nCP0;$	5 V		50	25	-	ns
		see Figure 5	10 V		30	15	-	ns
			15 V		20	10	-	ns
t _{rec}	recovery time	see Figure 5	5 V		50	25	-	ns
			10 V		30	15	-	ns
			15 V		20	10	-	ns
f _{max}	maximum	nCP0, nCP1;	5 V		8	16	-	MHz
	frequency	see Figure 5	10 V		15	30	-	MHz
			15 V		20	40	-	MHz

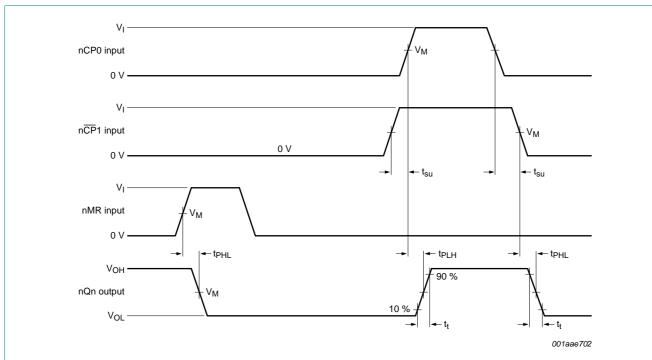
^[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

Table 8. Dynamic power dissipation P_D

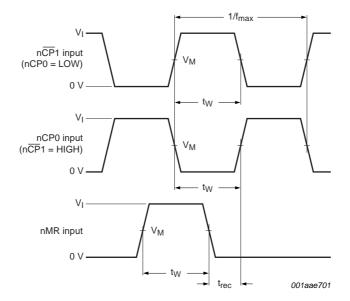
 P_D can be calculated from the formulas shown. $V_{SS} = 0 \ V$; $t_r = t_f \le 20 \ ns$; $T_{amb} = 25 \ ^{\circ}C$.

Symbol	Parameter	V_{DD}	Typical formula for P _D (μW)	Where:
P_{D}	dynamic power	5 V	$P_D = 850 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f_i = input frequency in MHz,
dissipation		10 V	$P_D = 3800 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f _o = output frequency in MHz,
		15 V	$P_D = 10200 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	C_L = output load capacitance in pF,
				V_{DD} = supply voltage in V,
				$\Sigma(f_0 \times C_L)$ = sum of the outputs.

11. Waveforms

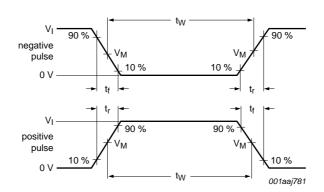


a. nCP0 and nCP1 set-up times, propagation delays and output transition times

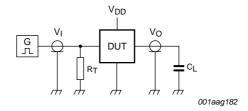


b. nMR recovery time, minimum nCP0, nCP1, and nMR pulse widths and maximum frequency Measurement points are given in <u>Table 9</u>.
 The logic levels V_{OH} and V_{OL} are typical output voltage levels that occur with the output load.

Fig 5. Waveforms showing measurements for switching times



a. Input waveforms



b. Test circuit

Test data is given in Table 9.

Definitions for test circuit:

DUT = Device Under Test;

C_L = Load capacitance including jig and probe capacitance;

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

Fig 6. Test circuit for measuring switching times

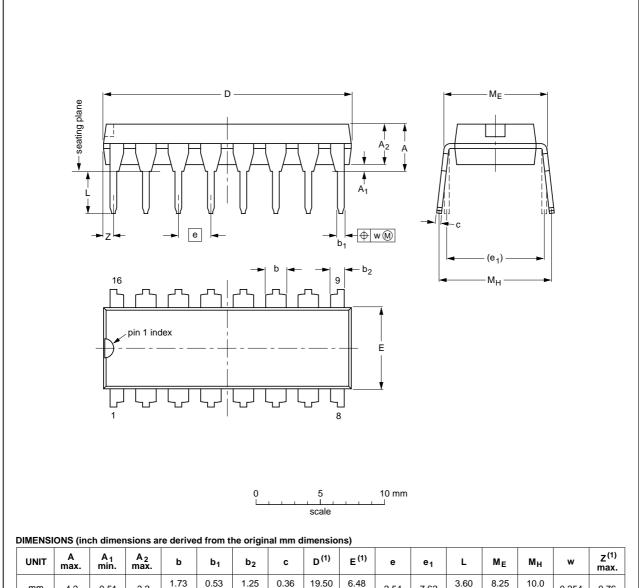
Table 9. Measurement points and test data

Supply voltage	Input	Load		
	V _I	V _M	t _r , t _f	CL
5 V to 15 V	V_{DD}	0.5V _I	≤ 20 ns	50 pF

12. Package outline

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT38-4					95-01-14 03-02-13

Fig 7. Package outline SOT38-4 (DIP16)

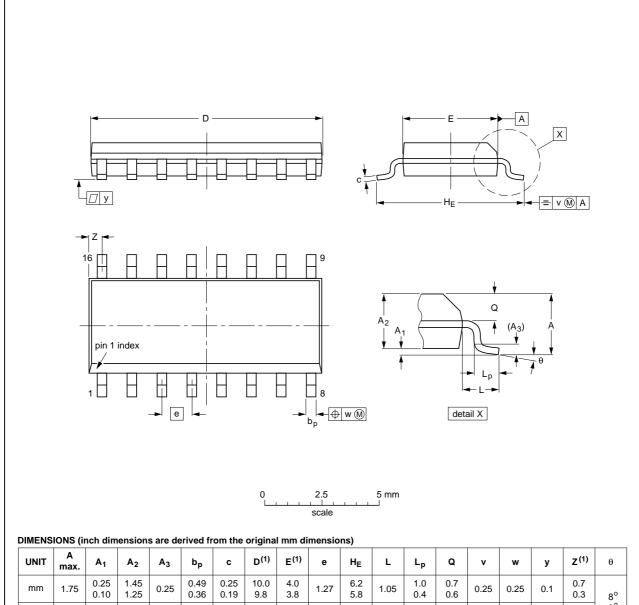
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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01	1	0.0100 0.0075	0.39 0.38	0.16 0.15	0.05	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-1	076E07	MS-012				99-12-27 03-02-19	
	•			•			

Fig 8. Package outline SOT109-1 (SO16)

HEF4520B

13. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4520B v.6	20111118	Product data sheet	-	HEF4520B v.5
Modifications:	 Section App 	olications removed		
	 <u>Table 6</u>: I_{OH} 	minimum values changed t	o maximum	
HEF4520B v.5	20091210	Product data sheet	-	HEF4520B v.4
HEF4520B v.4	20090828	Product data sheet	-	HEF4520B_CNV v.3
HEF4520B_CNV v.3	19950101	Product specification	-	HEF4520B_CNV v.2
HEF4520B_CNV v.2	19950101	Product specification	-	-

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Dual binary counter

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